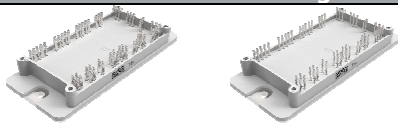
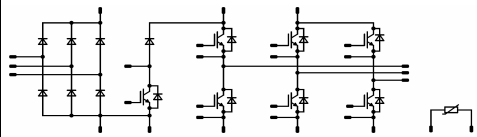




<i>flow PIM 2</i>	1200 V / 75 A
<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;"><b>Features</b></div> <ul style="list-style-type: none"> <li>Three-phase rectifier, BRC, Inverter, NTC</li> <li>Very Compact housing, easy to route</li> <li>IGBT4/ EmCon4 technology for low saturation losses and improved EMC behavior</li> </ul>	<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;"><b>flow 2 17mm housing</b></div> 
<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;"><b>Target Applications</b></div> <ul style="list-style-type: none"> <li>Motor Drives</li> <li>Power Generation</li> </ul>	<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;"><b>Schematic</b></div> 
<div style="background-color: #eee; padding: 2px; margin-bottom: 5px;"><b>Types</b></div> <ul style="list-style-type: none"> <li>V23990-P769-A</li> <li>V23990-P769-AY</li> </ul>	

## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Input Rectifier Diode</b>				
Repetitive peak reverse voltage	$V_{RRM}$		1600	V
Forward current	$I_{FAV}$		75	A
Surge (non-repetitive) forward current	$I_{FSM}$	$t_p = 10\text{ ms}$	1000	A
I2t-value	$I^2t$		5000	A <sup>2</sup> s
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	156	W
Maximum Junction Temperature	$T_{jmax}$		150	°C
<b>Inverter Switch</b>				
Collector-emitter breakdown voltage	$V_{CE}$		1200	V
DC collector current	$I_C$		70	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	210	A
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	239	W
Gate-emitter peak voltage	$V_{GE}$		±20	V
Short circuit ratings	$t_{SC}$	$T_j \leq 150\text{ °C}$	10	µs
	$V_{CC}$	$V_{GE} = 15\text{ V}$	800	V
Maximum Junction Temperature	$T_{jmax}$		175	°C



## Maximum Ratings

 $T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
-----------	--------	-----------	-------	------

### Inverter Diode

Peak Repetitive Reverse Voltage	$V_{RRM}$		1200	V
DC forward current	$I_F$		75	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	150	A
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	154	W
Maximum Junction Temperature	$T_{jmax}$		175	°C

### Brake Switch

Collector-emitter breakdown voltage	$V_{CE}$		1200	V
DC collector current	$I_C$		50	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	150	A
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	174	W
Gate-emitter peak voltage	$V_{GE}$		±20	V
Short circuit ratings	$t_{SC}$ $V_{CC}$	$T_j \leq 150\text{ °C}$ $V_{GE} = 15\text{ V}$	10 800	µs V
Maximum Junction Temperature	$T_{jmax}$		175	°C

### Brake Inverse Diode

Peak Repetitive Reverse Voltage	$V_{RRM}$		1200	V
DC forward current	$I_F$		10	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	20	A
Brake Inverse Diode	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	56	W
Maximum Junction Temperature	$T_{jmax}$		175	°C

### Brake Diode

Peak Repetitive Reverse Voltage	$V_{RRM}$		1200	V
DC forward current	$I_F$		25	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	50	A
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	87	W
Maximum Junction Temperature	$T_{jmax}$		175	°C

### Thermal properties

Storage temperature	$T_{stg}$		-40...+125	°C
Operation temperature under switching condition	$T_{op}$		-40...+ $T_{jmax}$ -25	°C

### Isolation Properties

Isolation voltage	$V_{isol}$	DC Test Voltage* $t_p = 2\text{ s}$	4000	V
		AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			min 12,7	mm
Clearance		with Press-fit pins / with Solder pins	11,58 / 11,82	mm
Comparative Tracking Index	CTI		>200	

\* 100 % tested in production



### Characteristic Values

Parameter	Symbol	Conditions					Value			Unit	
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_r$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_F$ [A]	$I_D$ [A]		$T_j$ [°C]

#### Input Rectifier Diode

Forward voltage	$V_F$					100	25 125		1,18 1,16	1,9		V
Threshold voltage (for power loss calc. only)	$V_{to}$						25 125		0,87 0,79			V
Slope resistance (for power loss calc. only)	$r_t$						25 125		0,003 0,004			Ω
Reverse current	$I_r$				1500		25 125			0,05 1,1		mA
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)							0,45			K/W

#### Inverter Switch

Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$				0,0024	25		5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CEsat}$		15			75	25 150			1,96 2,47	2,1	V
Collector-emitter cut-off current incl. Diode	$I_{CES}$		0	1200			25				0,025	mA
Gate-emitter leakage current	$I_{GES}$		20	0			25				200	nA
Integrated Gate resistor	$R_{gint}$									none		Ω
Turn-on delay time	$t_{d(on)}$	$R_{goff} = 8 \Omega$ $R_{gon} = 8 \Omega$	$\pm 15$	600	75		25			106		ns
Rise time	$t_r$						150			86		
Turn-off delay time	$t_{d(off)}$						25			24		
Fall time	$t_f$						150			23		
Turn-on energy loss	$E_{on}$						25			188		
Turn-off energy loss	$E_{off}$						150			270		
Input capacitance	$C_{ies}$	$f = 1$ MHz	0	25		25				3900		pF
Output capacitance	$C_{oss}$									310		
Reverse transfer capacitance	$C_{rss}$									230		
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)							0,40			K/W

#### Inverter Diode

Diode forward voltage	$V_F$					75	25 150			1,81 1,83	2,4	V
Peak reverse recovery current	$I_{RRM}$	$R_{gon} = 8 \Omega$	$\pm 15$	600	75		25			46,6		A
Reverse recovery time	$t_{rr}$						150			117		
Reverse recovered charge	$Q_{rr}$						25			287		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$						150			310		
Reverse recovered energy	$E_{rec}$						25			4,17		
							150			14,13		
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)							0,62			K/W



### Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_r$ [V] $V_{CE}$ [V] $V_{DS}$ [V]	$I_C$ [A] $I_F$ [A] $I_D$ [A]	$T_j$ [°C]	Min	Typ	Max		
<b>Brake Switch</b>										
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0017	25	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CEsat}$		15		50	25 150		1,9 2,3	2,3	V
Collector-emitter cut-off incl diode	$I_{CES}$		0	1200		25			0,25	mA
Gate-emitter leakage current	$I_{GES}$		20	0		25			200	nA
Integrated Gate resistor	$R_{gint}$							4		Ω
Turn-on delay time	$t_{d(on)}$					25 150		98 103		ns
Rise time	$t_r$					25 150		18 25		
Turn-off delay time	$t_{d(off)}$	$R_{gon} = 8 \Omega$ $R_{goff} = 8 \Omega$	±15	600	50	25 150		208 284		
Fall time	$t_f$					25 150		66 112		
Turn-on energy loss	$E_{on}$					25 150		2,43 3,46		mWs
Turn-off energy loss	$E_{off}$					25 150		2,45 4,23		
Input capacitance	$C_{ies}$							2770		pF
Output capacitance	$C_{oss}$	$f = 1 \text{ MHz}$	0	25		25		205		
Reverse transfer capacitance	$C_{rss}$							160		
Gate charge	$Q_G$		±15	960		25		290		nC
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,54		K/W
<b>Brake Inverse Diode</b>										
Diode forward voltage	$V_F$				10	25 150	1,1	1,81 1,81	2,1	V
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,68		K/W
<b>Brake Diode</b>										
Diode forward voltage	$V_F$				25	25 150		1,82 1,82	2,2	V
Reverse leakage current	$I_r$			600		25			10	μA
Peak reverse recovery current	$I_{RRM}$					25 150		51 52		A
Reverse recovery time	$t_{rr}$					25 150		152 328		ns
Reverse recovered charge	$Q_{rr}$	$R_{gon} = 8 \Omega$	±15	600	50	25 150		3,07 6,3		μC
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 150		3443 806		A/μs
Reverse recovery energy	$E_{rec}$					25 150		3,07 6,3		mWs
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,09		K/W
<b>Thermistor</b>										
Rated resistance	$R_{25}$					25		22		kΩ
Deviation of $R_{100}$	$D_{R/R}$	$R_{100} = 1486 \Omega$				100	-12		12	%
Power dissipation	$P$					25		200		mW
Power dissipation constant						25		2		mW/K
B-value	$B_{(25/50)}$	Tol. ±3%				25		3950		K
B-value	$B_{(25/100)}$	Tol. ±3%				25		3998		K
Vincotech NTC Reference									B	

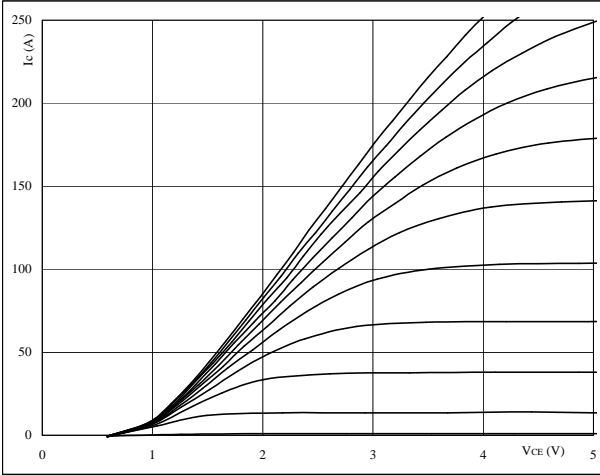


# Output Inverter

**figure 1.** IGBT

**Typical output characteristics**

$I_C = f(V_{CE})$



**At**

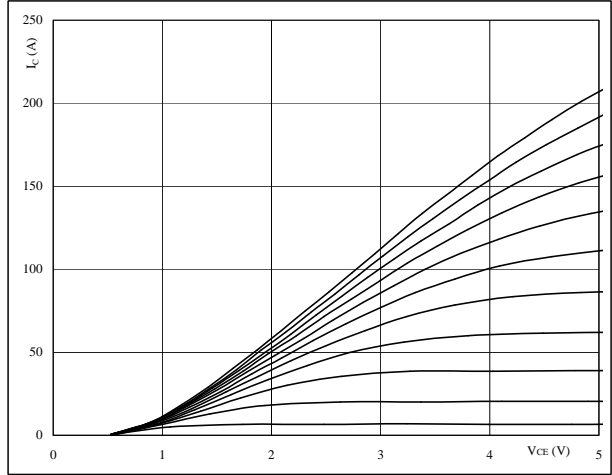
$t_p = 250 \mu s$   
 $T_j = 25 \text{ } ^\circ C$

VGE from 7 V to 17 V in steps of 1 V

**figure 2.** IGBT

**Typical output characteristics**

$I_C = f(V_{CE})$



**At**

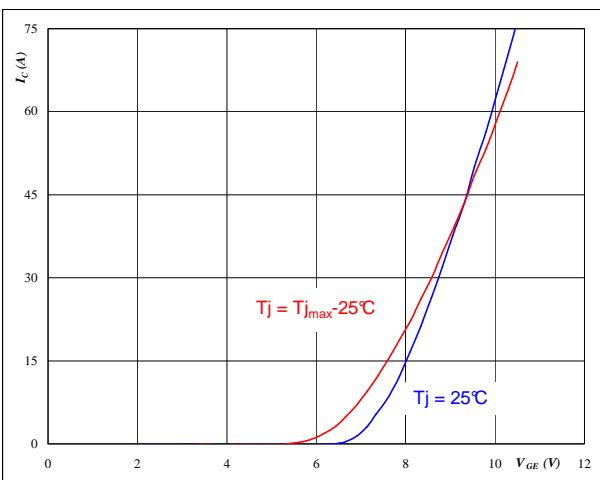
$t_p = 250 \mu s$   
 $T_j = 150 \text{ } ^\circ C$

VGE from 7 V to 17 V in steps of 1 V

**figure 3.** IGBT

**Typical transfer characteristics**

$I_C = f(V_{GE})$



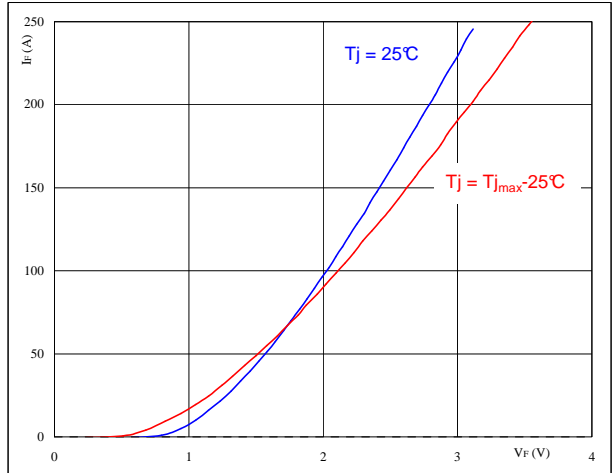
**At**

$t_p = 250 \mu s$   
 $V_{CE} = 10 \text{ V}$

**figure 4.** FWD

**Typical diode forward current as a function of forward voltage**

$I_F = f(V_F)$



**At**

$t_p = 250 \mu s$

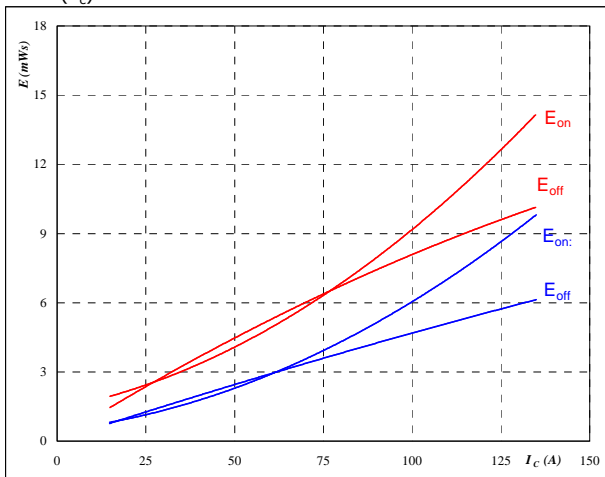


# Output Inverter

**figure 5.** IGBT

Typical switching energy losses  
as a function of collector current

$E = f(I_C)$



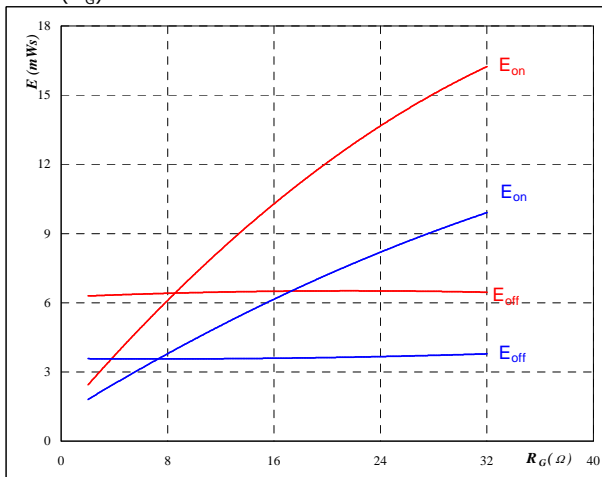
With an inductive load at

- $T_j = 25/150$  °C
- $V_{CE} = 600$  V
- $V_{GE} = \pm 15$  V
- $R_{gon} = 8$  Ω
- $R_{goff} = 8$  Ω

**figure 6.** IGBT

Typical switching energy losses  
as a function of gate resistor

$E = f(R_G)$



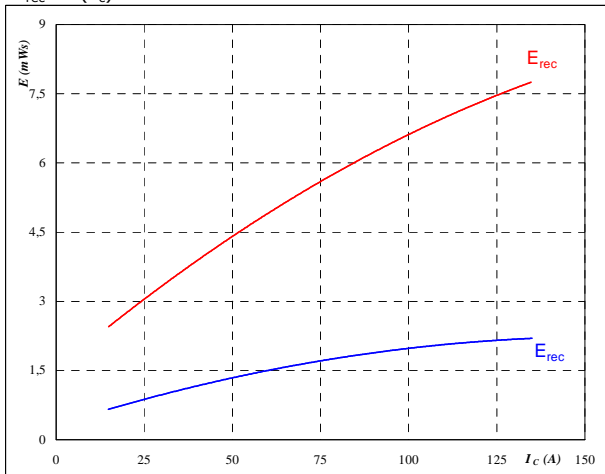
With an inductive load at

- $T_j = 25/150$  °C
- $V_{CE} = 600$  V
- $V_{GE} = \pm 15$  V
- $I_C = 75$  A

**figure 7.** IGBT

Typical reverse recovery energy loss  
as a function of collector current

$E_{rec} = f(I_C)$



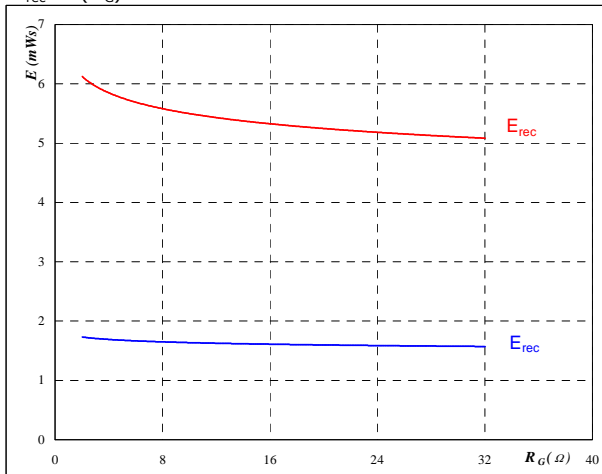
With an inductive load at

- $T_j = 25/150$  °C
- $V_{CE} = 600$  V
- $V_{GE} = \pm 15$  V
- $R_{gon} = 8$  Ω

**figure 8.** IGBT

Typical reverse recovery energy loss  
as a function of gate resistor

$E_{rec} = f(R_G)$



With an inductive load at

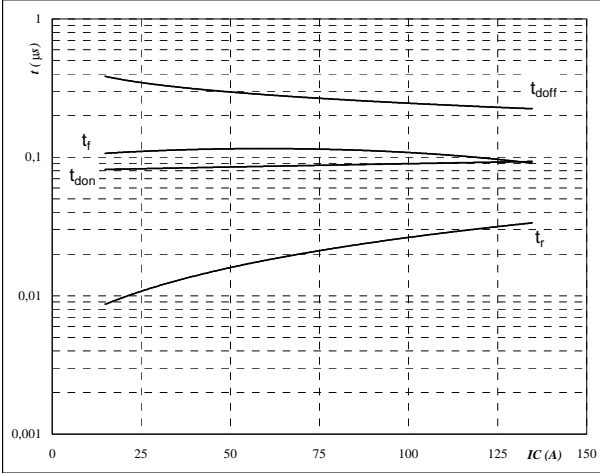
- $T_j = 25/150$  °C
- $V_{CE} = 600$  V
- $V_{GE} = \pm 15$  V
- $I_C = 75$  A



# Output Inverter

**figure 9. IGBT**

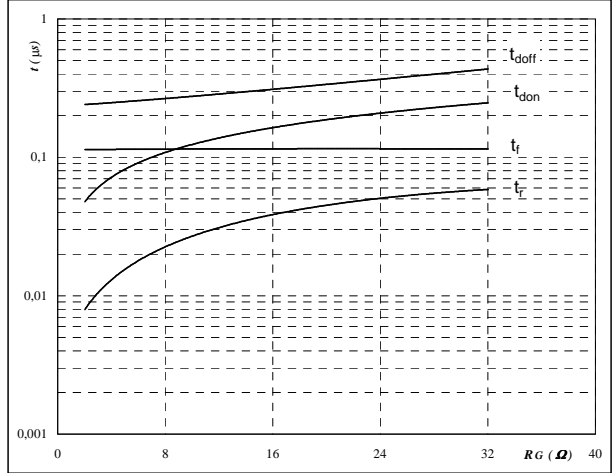
**Typical switching times as a function of collector current**  
 $t = f(I_C)$



With an inductive load at  
 $T_j = 150 \text{ } ^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 8 \text{ } \Omega$   
 $R_{goff} = 8 \text{ } \Omega$

**figure 10. IGBT**

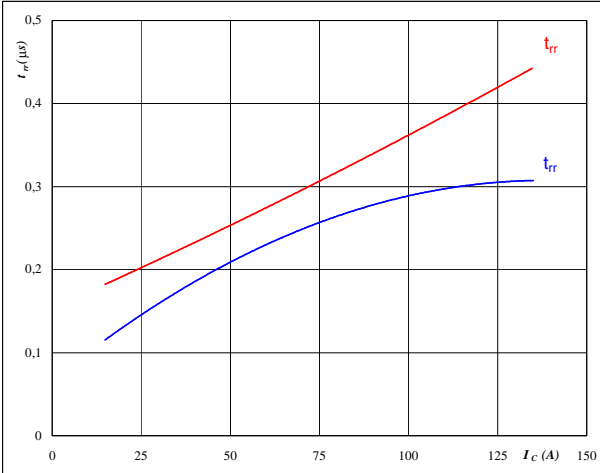
**Typical switching times as a function of gate resistor**  
 $t = f(R_G)$



With an inductive load at  
 $T_j = 150 \text{ } ^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 75 \text{ A}$

**figure 11. FWD**

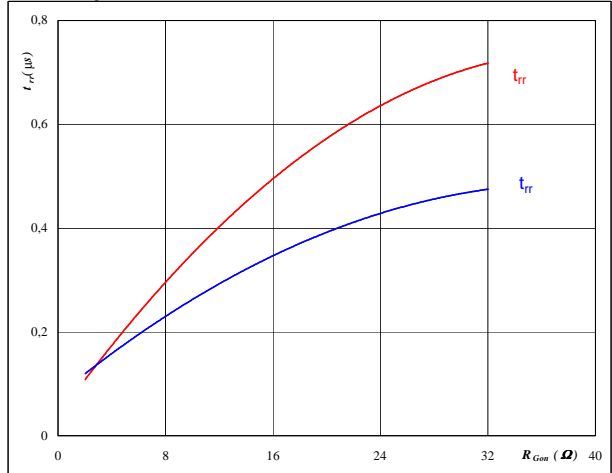
**Typical reverse recovery time as a function of collector current**  
 $t_{rr} = f(I_C)$



**At**  
 $T_j = 25/150 \text{ } ^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 8 \text{ } \Omega$

**figure 12. FWD**

**Typical reverse recovery time as a function of IGBT turn on gate resistor**  
 $t_{rr} = f(R_{gon})$



**At**  
 $T_j = 25/150 \text{ } ^\circ\text{C}$   
 $V_R = 600 \text{ V}$   
 $I_F = 75 \text{ A}$   
 $V_{GE} = \pm 15 \text{ V}$

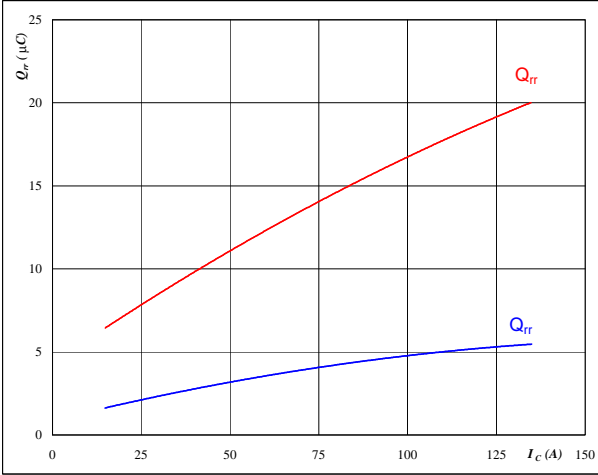


# Output Inverter

figure 13. FWD

Typical reverse recovery charge as a function of collector current

$$Q_{rr} = f(I_c)$$

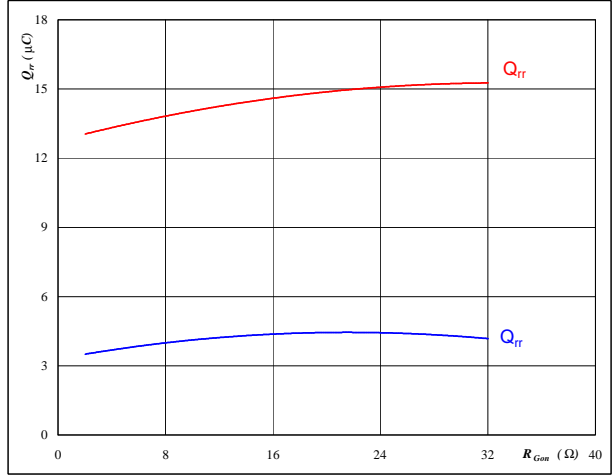


**At**  
 $T_j = 25/150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 8$  Ω

figure 14. FWD

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$$Q_{rr} = f(R_{gon})$$

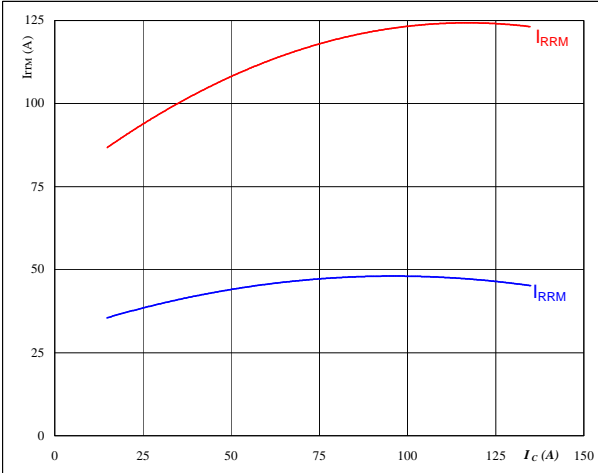


**At**  
 $T_j = 25/150$  °C  
 $V_R = 600$  V  
 $I_F = 75$  A  
 $V_{GE} = \pm 15$  V

figure 15. FWD

Typical reverse recovery current as a function of collector current

$$I_{RRM} = f(I_c)$$

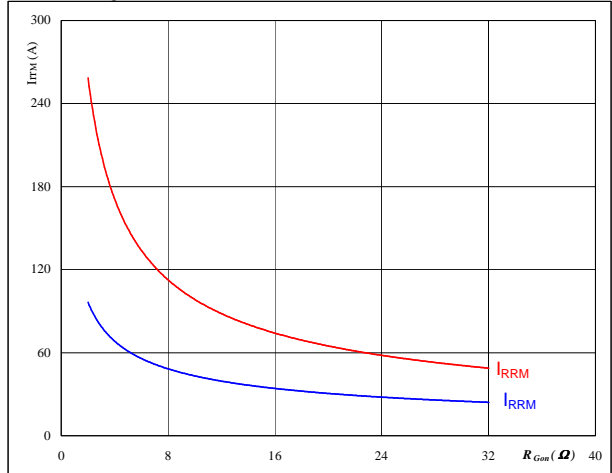


**At**  
 $T_j = 25/150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 8$  Ω

figure 16. FWD

Typical reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RRM} = f(R_{gon})$$



**At**  
 $T_j = 25/150$  °C  
 $V_R = 600$  V  
 $I_F = 75$  A  
 $V_{GE} = \pm 15$  V



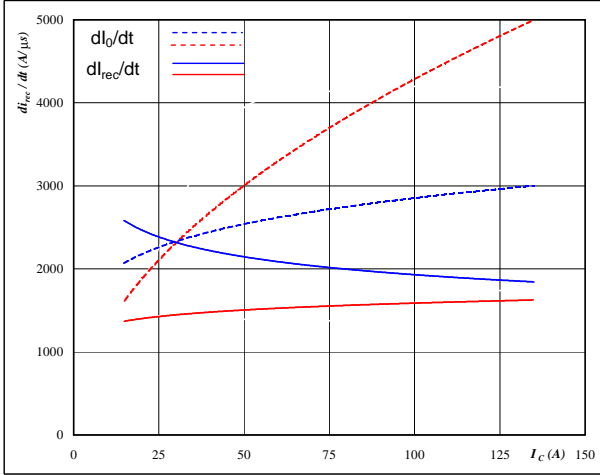


# Output Inverter

**figure 17.** FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current

$$dI_o/dt, dI_{rec}/dt = f(I_c)$$

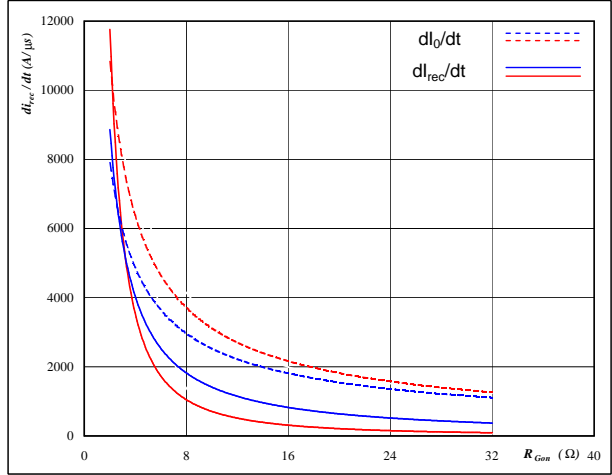


**At**  
 $T_j = 25/150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 8$  Ω

**figure 18.** FWD

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$$dI_o/dt, dI_{rec}/dt = f(R_{gon})$$

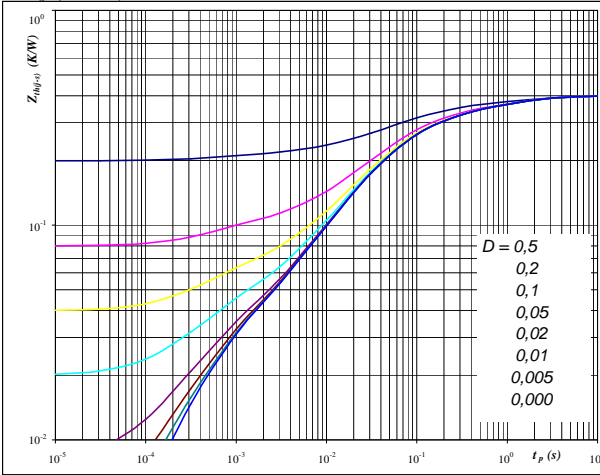


**At**  
 $T_j = 25/150$  °C  
 $V_R = 600$  V  
 $I_F = 75$  A  
 $V_{GE} = \pm 15$  V

**figure 19.** IGBT

IGBT transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



**At**  
 $D = t_p / T$   
 $R_{th(j-s)} = 0,40$  K/W

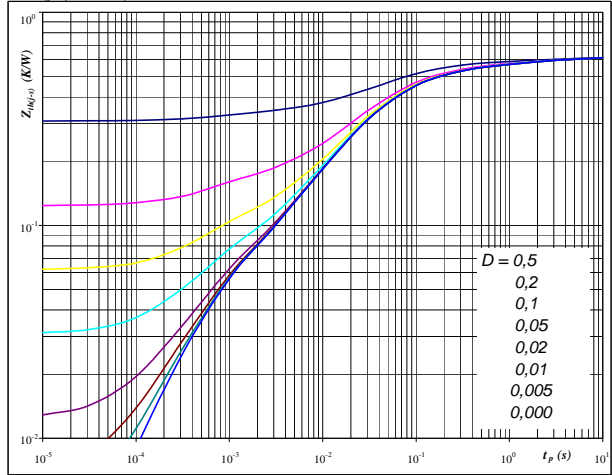
IGBT thermal model values

R (K/W)	Tau (s)
6,24E-02	1,56E+00
9,03E-02	2,15E-01
1,40E-01	5,06E-02
6,78E-02	1,56E-02
1,66E-02	3,11E-03
2,14E-02	4,58E-04

**figure 20.** FWD

FWD transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



**At**  
 $D = t_p / T$   
 $R_{th(j-s)} = 0,62$  K/W

FWD thermal model values

R (K/W)	Tau (s)
4,35E-02	4,66E+00
7,48E-02	5,44E-01
1,95E-01	8,13E-02
2,13E-01	2,26E-02
4,51E-02	5,48E-03
4,51E-02	5,92E-04

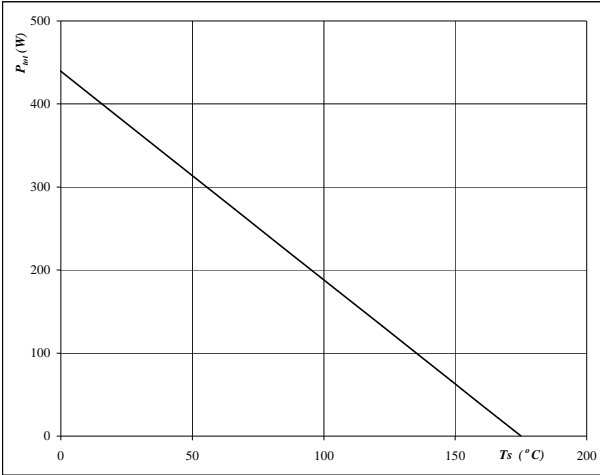


# Output Inverter

**figure 21.** IGBT

**Power dissipation as a function of heatsink temperature**

$$P_{tot} = f(T_s)$$

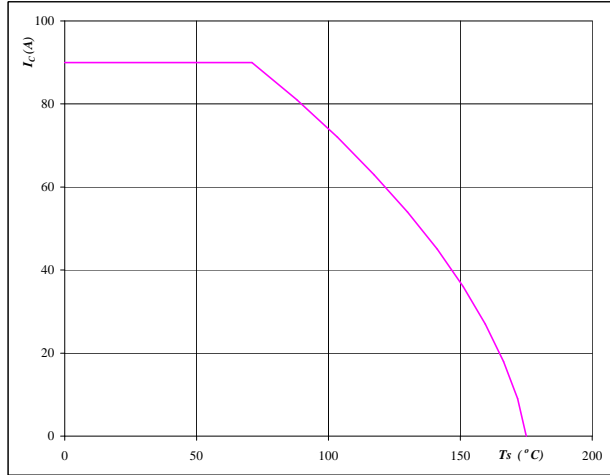


**At**  
T<sub>j</sub> = 175 °C

**figure 22.** IGBT

**Collector current as a function of heatsink temperature**

$$I_C = f(T_s)$$

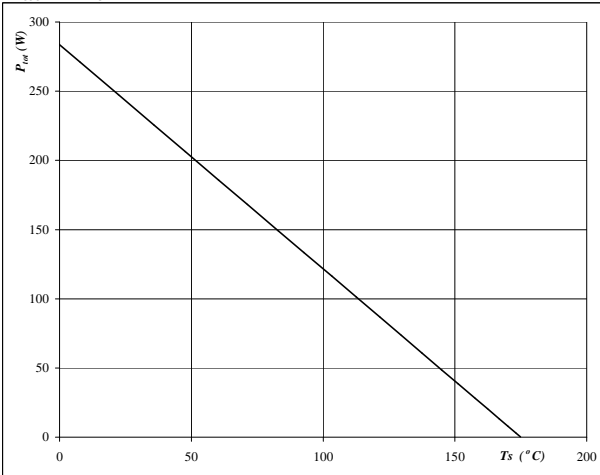


**At**  
T<sub>j</sub> = 175 °C  
V<sub>GE</sub> = 15 V

**figure 23.** FWD

**Power dissipation as a function of heatsink temperature**

$$P_{tot} = f(T_s)$$

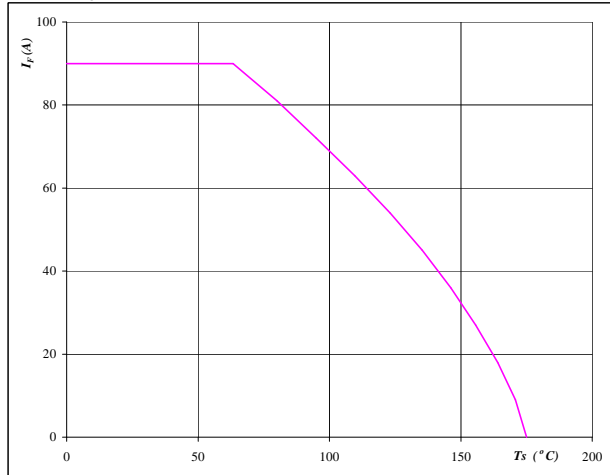


**At**  
T<sub>j</sub> = 175 °C

**figure 24.** FWD

**Forward current as a function of heatsink temperature**

$$I_F = f(T_s)$$



**At**  
T<sub>j</sub> = 175 °C

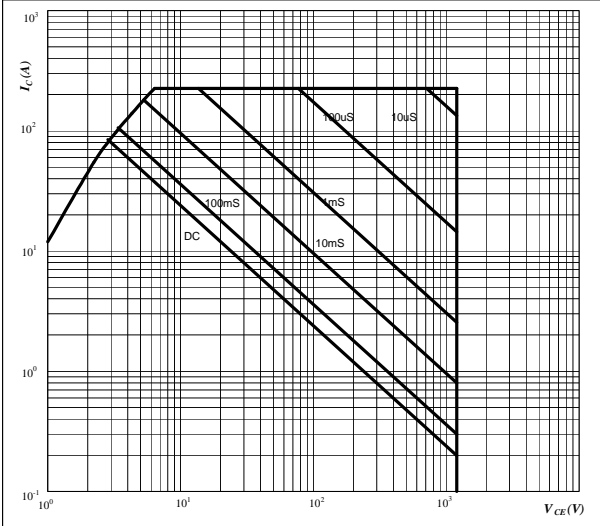


# Output Inverter

**figure 25.** IGBT

**Safe operating area as a function of collector-emitter voltage**

$I_C = f(V_{CE})$

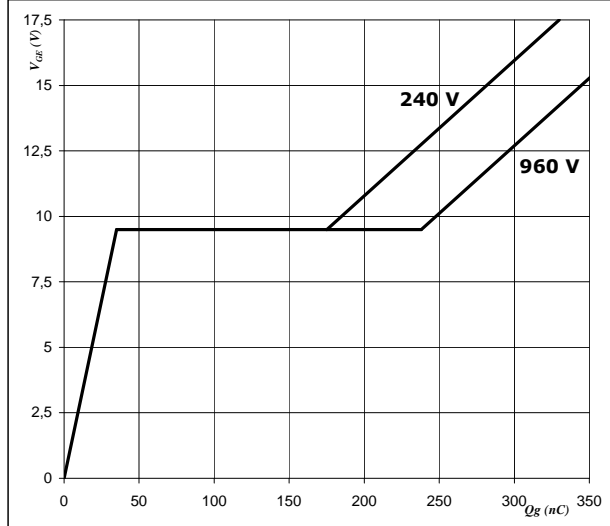


**At**  
 $D =$  single pulse  
 $T_s =$  80 °C  
 $V_{GE} =$  ±15 V  
 $T_j = T_{jmax}$

**figure 26.** IGBT

**Gate voltage vs Gate charge**

$V_{GE} = f(Q_g)$



**At**  
 $I_C =$  75 A

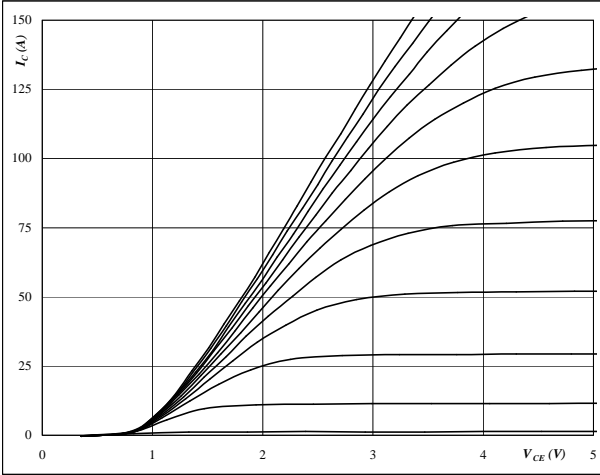


# Brake

**figure 1. IGBT**

**Typical output characteristics**

$I_C = f(V_{CE})$



**At**

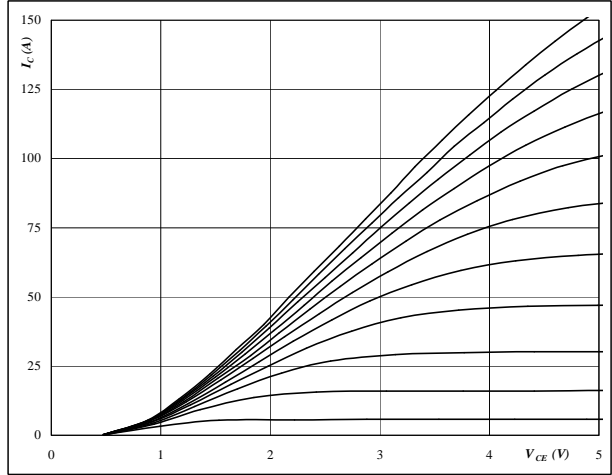
$t_p = 250 \mu s$   
 $T_j = 25 \text{ } ^\circ C$

VGE from 7 V to 17 V in steps of 1 V

**figure 2. IGBT**

**Typical output characteristics**

$I_C = f(V_{CE})$



**At**

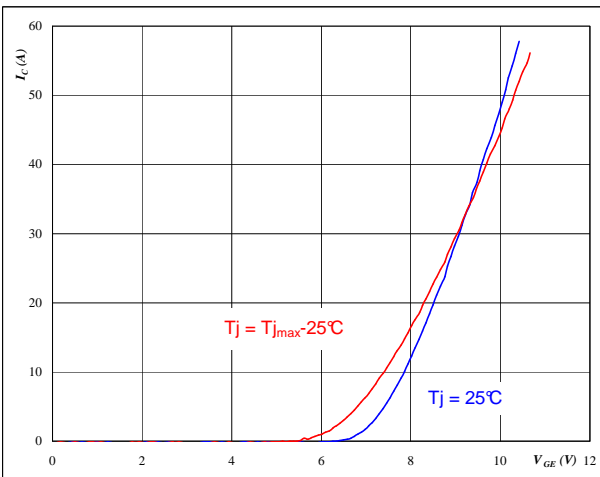
$t_p = 250 \mu s$   
 $T_j = 150 \text{ } ^\circ C$

VGE from 7 V to 17 V in steps of 1 V

**figure 3. IGBT**

**Typical transfer characteristics**

$I_C = f(V_{GE})$



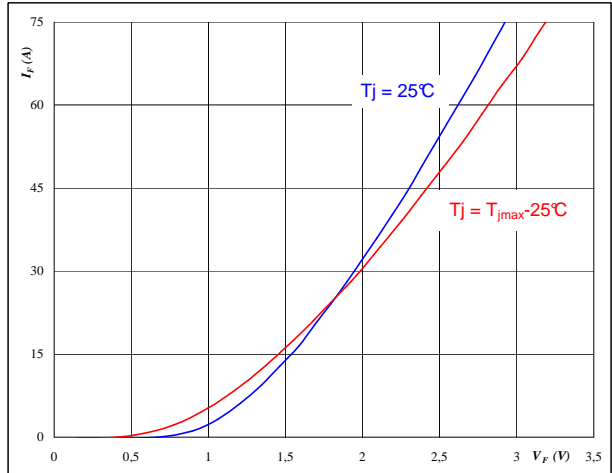
**At**

$t_p = 250 \mu s$   
 $V_{CE} = 10 V$

**figure 4. FWD**

**Typical diode forward current as a function of forward voltage**

$I_F = f(V_F)$



**At**

$t_p = 250 \mu s$

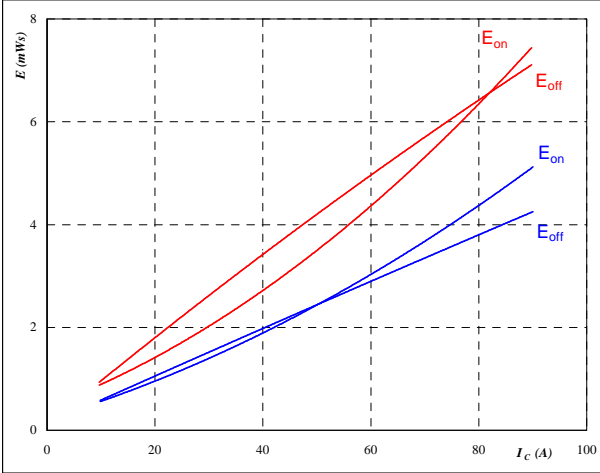


# Brake

**figure 5.** IGBT

Typical switching energy losses  
as a function of collector current

$E = f(I_C)$



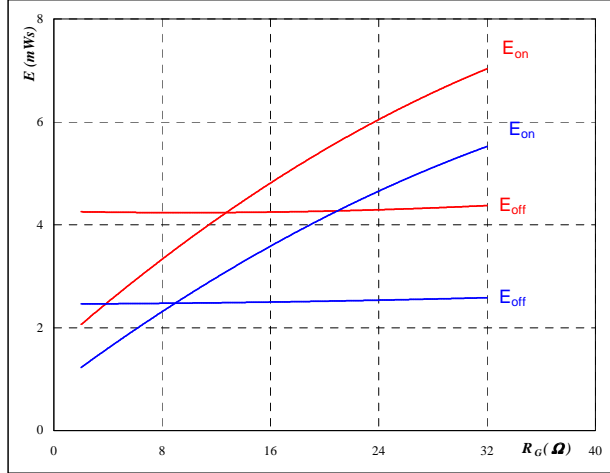
With an inductive load at

- $T_j = 25/150$  °C
- $V_{CE} = 600$  V
- $V_{GE} = \pm 15$  V
- $R_{gon} = 8$  Ω
- $R_{goff} = 8$  Ω

**figure 6.** IGBT

Typical switching energy losses  
as a function of gate resistor

$E = f(R_G)$



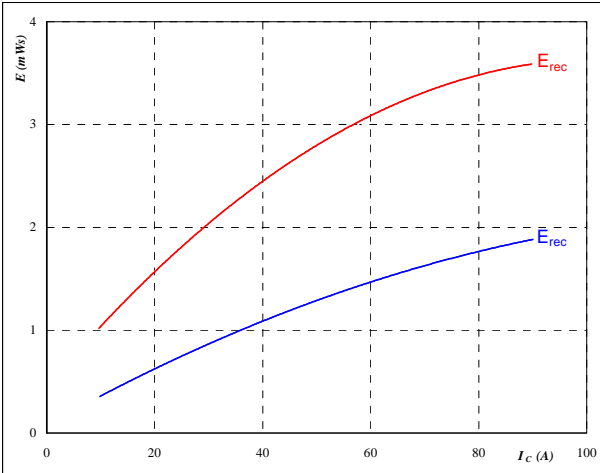
With an inductive load at

- $T_j = 25/150$  °C
- $V_{CE} = 600$  V
- $V_{GE} = \pm 15$  V
- $I_C = 50$  A

**figure 7.** IGBT

Typical reverse recovery energy loss  
as a function of collector current

$E_{rec} = f(I_C)$



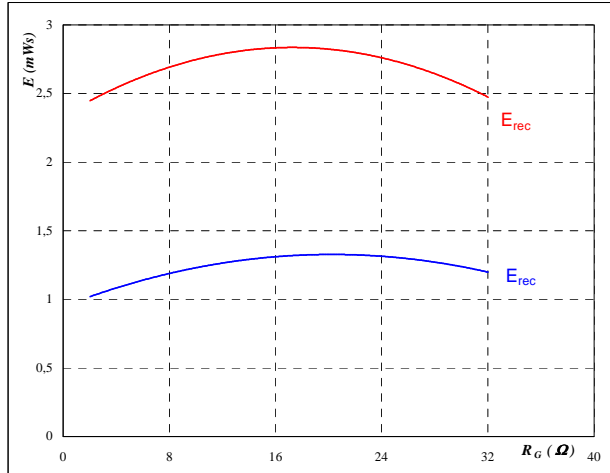
With an inductive load at

- $T_j = 25/150$  °C
- $V_{CE} = 600$  V
- $V_{GE} = \pm 15$  V
- $R_{gon} = 8$  Ω

**figure 8.** IGBT

Typical reverse recovery energy loss  
as a function of gate resistor

$E_{rec} = f(R_G)$



With an inductive load at

- $T_j = 25/150$  °C
- $V_{CE} = 600$  V
- $V_{GE} = \pm 15$  V
- $I_C = 50$  A

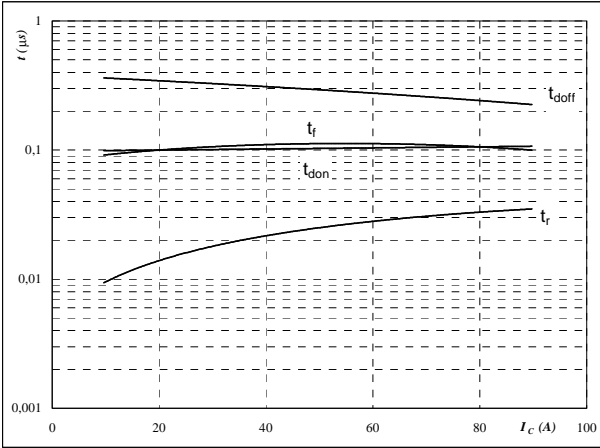


# Brake

**figure 9. IGBT**

Typical switching times as a function of collector current

$t = f(I_C)$



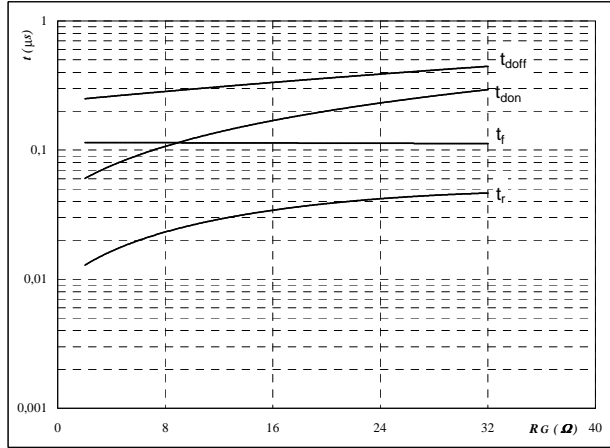
With an inductive load at

- $T_j = 150 \text{ } ^\circ\text{C}$
- $V_{CE} = 600 \text{ V}$
- $V_{GE} = \pm 15 \text{ V}$
- $R_{gon} = 8 \text{ } \Omega$
- $R_{goff} = 8 \text{ } \Omega$

**figure 10. IGBT**

Typical switching times as a function of gate resistor

$t = f(R_G)$



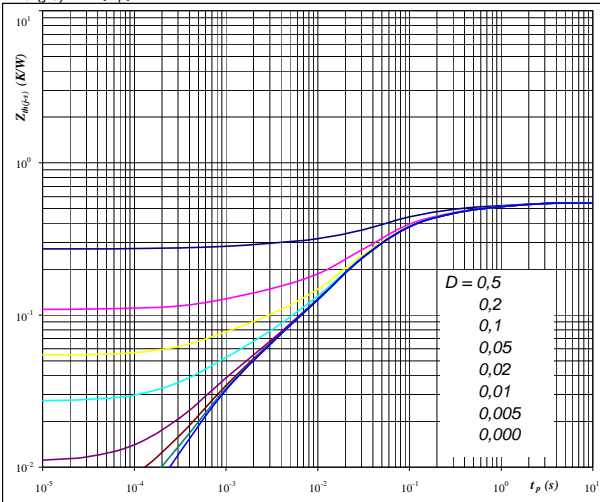
With an inductive load at

- $T_j = 150 \text{ } ^\circ\text{C}$
- $V_{CE} = 600 \text{ V}$
- $V_{GE} = \pm 15 \text{ V}$
- $I_C = 50 \text{ A}$

**figure 11. IGBT**

IGBT transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$



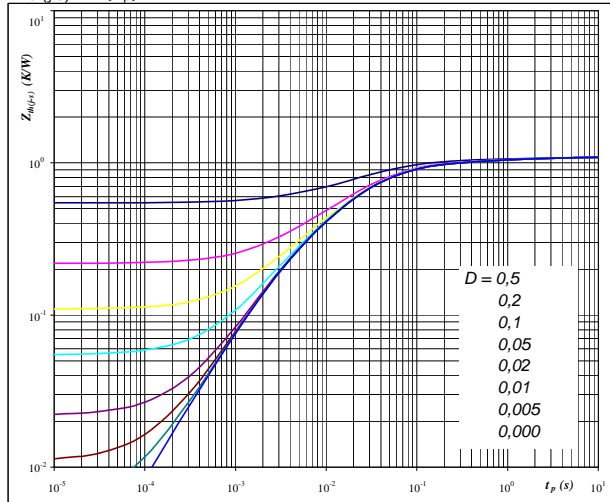
At

- $D = t_p / T$
- $R_{th(j-s)} = 0,54 \text{ K/W}$

**figure 12. IGBT**

FWD transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$



At

- $D = t_p / T$
- $R_{th(j-s)} = 1,09 \text{ K/W}$

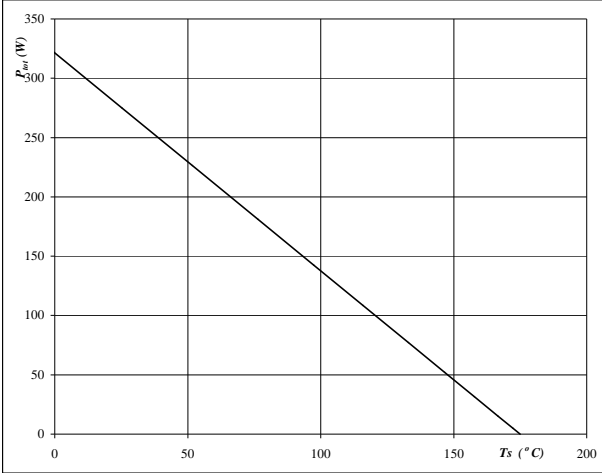


# Brake

**figure 13.** IGBT

**Power dissipation as a function of heatsink temperature**

$$P_{tot} = f(T_s)$$

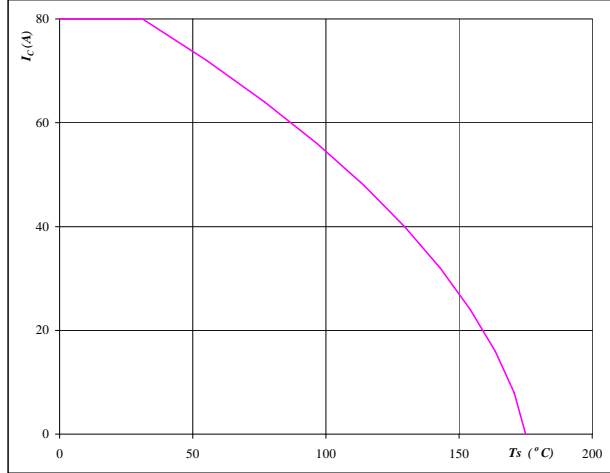


**At**  
T<sub>j</sub> = 175 °C

**figure 14.** IGBT

**Collector current as a function of heatsink temperature**

$$I_C = f(T_s)$$

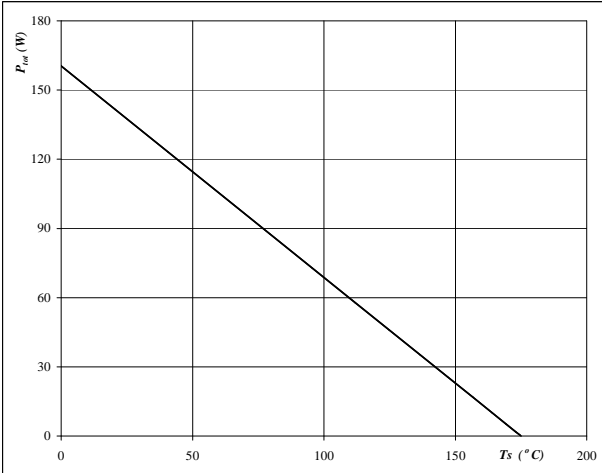


**At**  
T<sub>j</sub> = 175 °C  
V<sub>GE</sub> = 15 V

**figure 15.** FWD

**Power dissipation as a function of heatsink temperature**

$$P_{tot} = f(T_s)$$

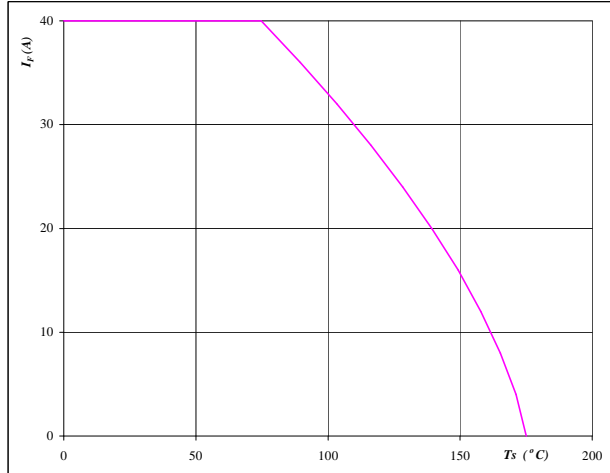


**At**  
T<sub>j</sub> = 175 °C

**figure 16.** FWD

**Forward current as a function of heatsink temperature**

$$I_F = f(T_s)$$



**At**  
T<sub>j</sub> = 175 °C

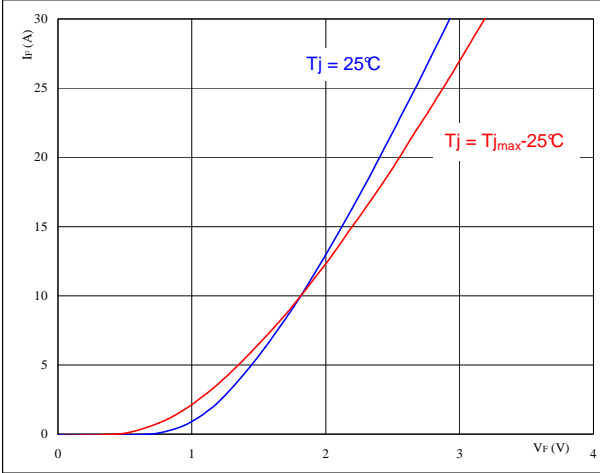


# Brake Inverse Diode

**figure 1. Brake inverse diode**

Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$

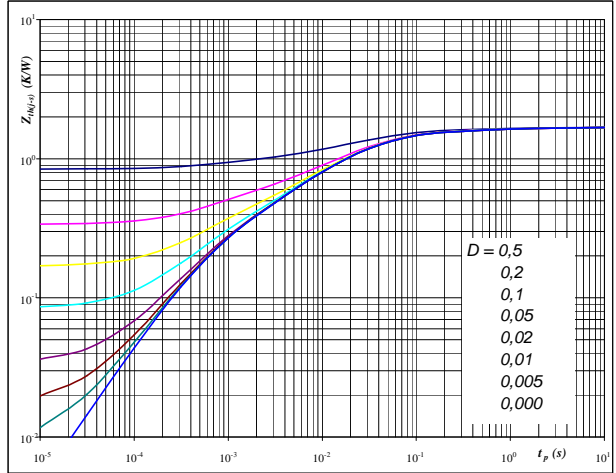


**At**  
 $t_p = 250 \mu s$

**figure 2. Brake inverse diode**

Diode transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

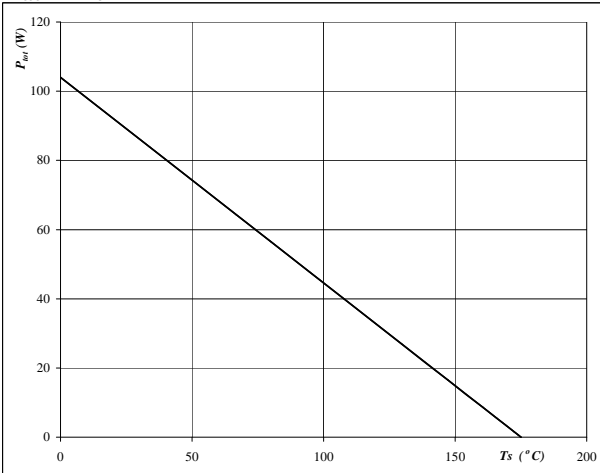


**At**  
 $D = t_p / T$   
 $R_{th(j-s)} = 1,68 K/W$

**figure 3. Brake inverse diode**

Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_s)$$

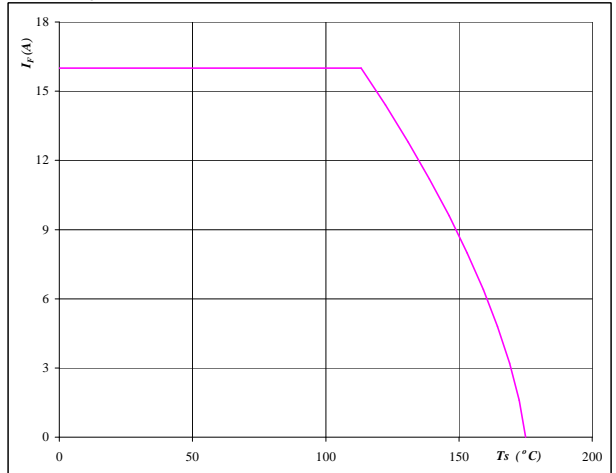


**At**  
 $T_j = 175 \text{ } ^\circ C$

**figure 4. Brake inverse diode**

Forward current as a function of heatsink temperature

$$I_F = f(T_s)$$



**At**  
 $T_j = 175 \text{ } ^\circ C$



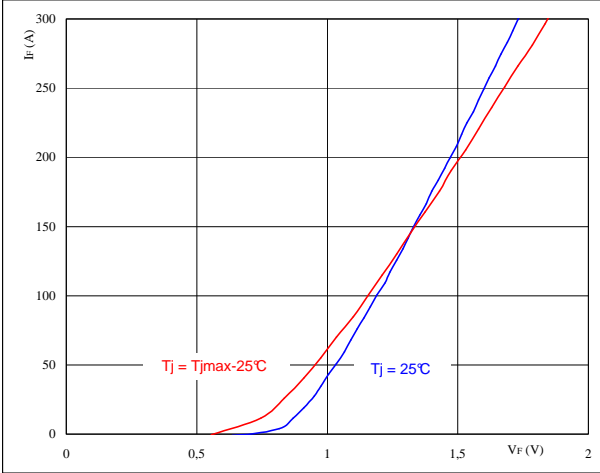


# Input Rectifier Bridge

**figure 1. Rectifier Diode**

Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$

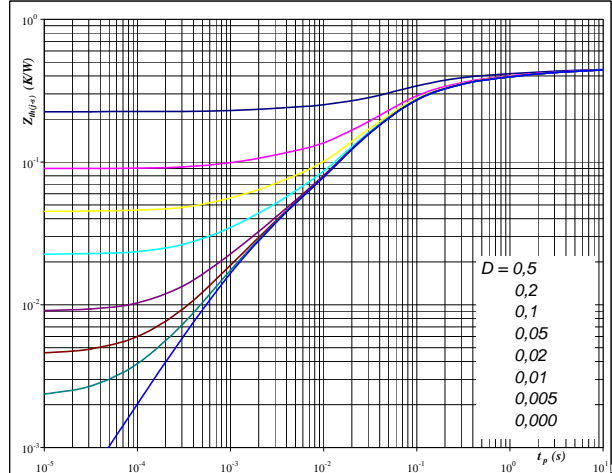


At  
 $t_p = 250 \mu s$

**figure 2. Rectifier Diode**

Diode transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

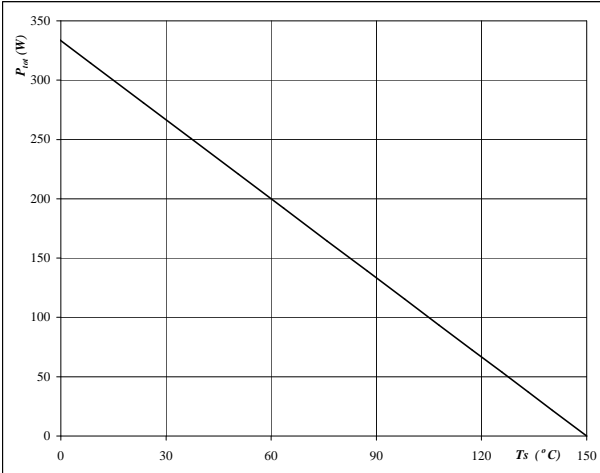


At  
 $D = t_p / T$   
 $R_{th(j-s)} = 0,45 \text{ K/W}$

**figure 3. Rectifier Diode**

Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_s)$$

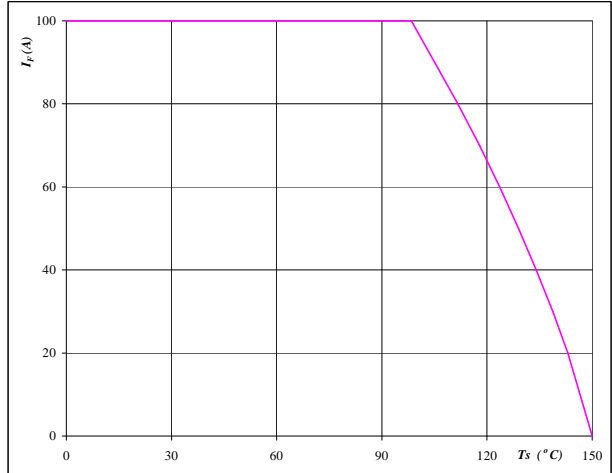


At  
 $T_j = 150 \text{ °C}$

**figure 4. Rectifier Diode**

Forward current as a function of heatsink temperature

$$I_F = f(T_s)$$



At  
 $T_j = 150 \text{ °C}$

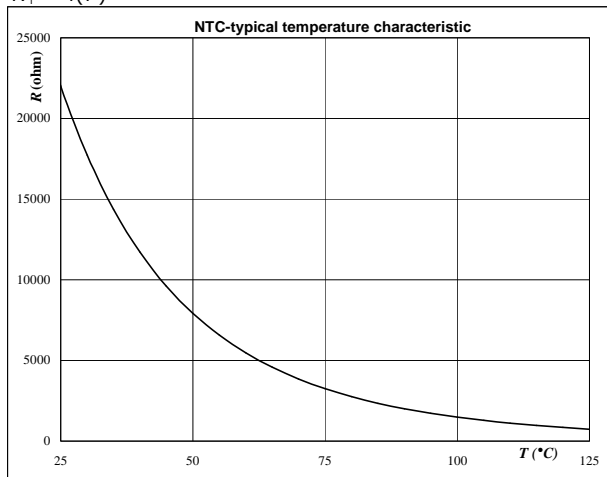


# Thermistor

**figure 1. Thermistor**

**Typical NTC characteristic  
as a function of temperature**

$$R_T = f(T)$$





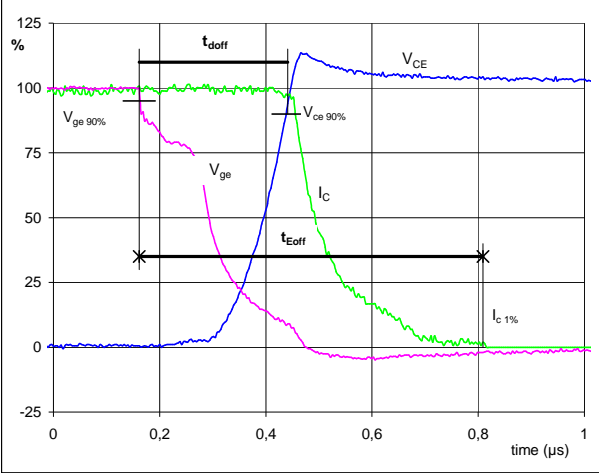
# Switching Definitions Output Inverter

**General conditions**

$T_j$	=	150 °C
$R_{gon}$	=	8 Ω
$R_{goff}$	=	8 Ω

**figure 1. IGBT**

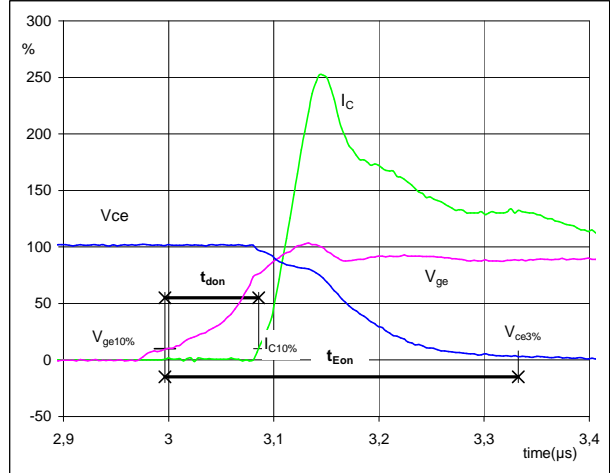
**Turn-off Switching Waveforms & definition of  $t_{doff}$   $t_{Eoff}$**   
( $t_{Eoff}$  = integrating time for  $E_{off}$ )



$V_{GE}$ (0%) =	-15	V
$V_{GE}$ (100%) =	15	V
$V_C$ (100%) =	600	V
$I_C$ (100%) =	75	A
$t_{doff}$ =	0,27	μs
$t_{Eoff}$ =	0,65	μs

**figure 2. IGBT**

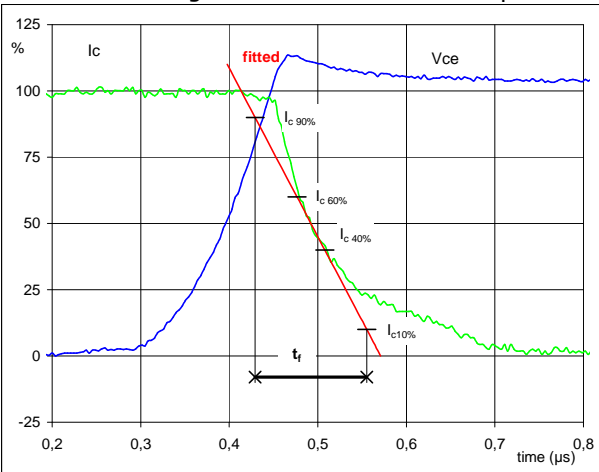
**Turn-on Switching Waveforms & definition of  $t_{don}$   $t_{Eon}$**   
( $t_{Eon}$  = integrating time for  $E_{on}$ )



$V_{GE}$ (0%) =	-15	V
$V_{GE}$ (100%) =	15	V
$V_C$ (100%) =	600	V
$I_C$ (100%) =	75	A
$t_{don}$ =	0,09	μs
$t_{Eon}$ =	0,34	μs

**figure 3. IGBT**

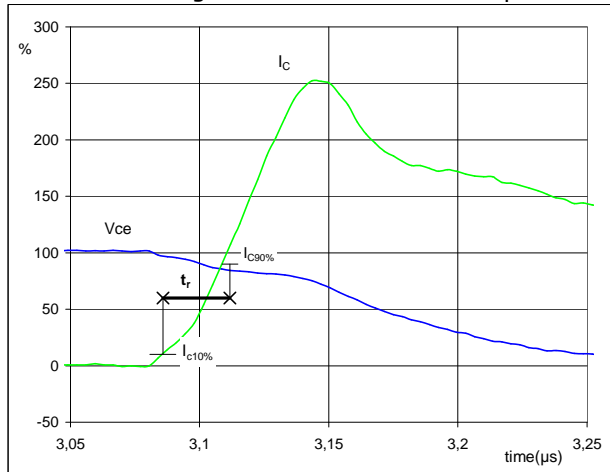
**Turn-off Switching Waveforms & definition of  $t_f$**



$V_C$ (100%) =	600	V
$I_C$ (100%) =	75	A
$t_f$ =	0,11	μs

**figure 4. IGBT**

**Turn-on Switching Waveforms & definition of  $t_r$**

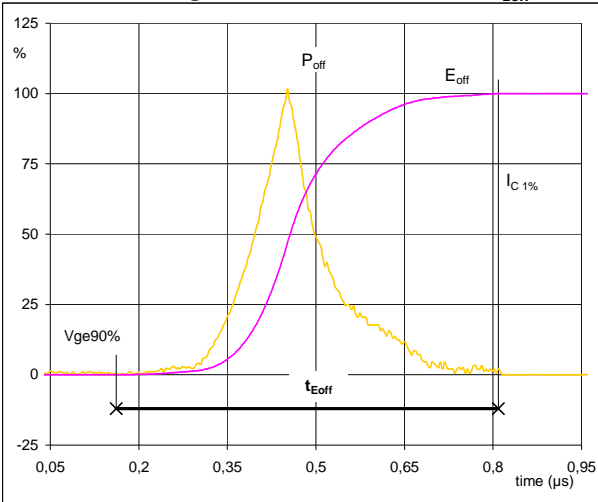


$V_C$ (100%) =	600	V
$I_C$ (100%) =	75	A
$t_r$ =	0,02	μs



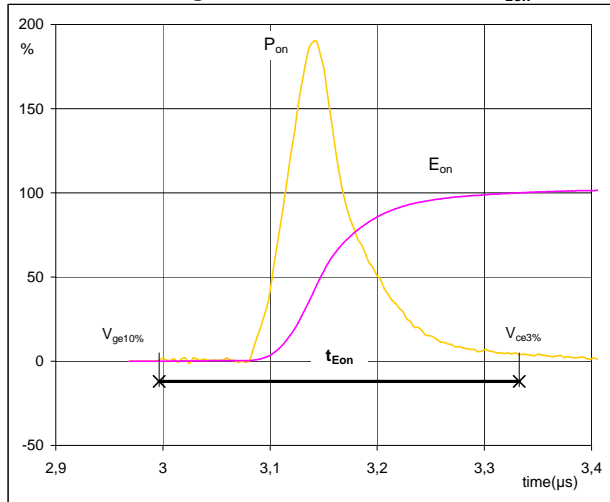
## Switching Definitions Output Inverter

**figure 5. IGBT**  
**Turn-off Switching Waveforms & definition of  $t_{Eoff}$**



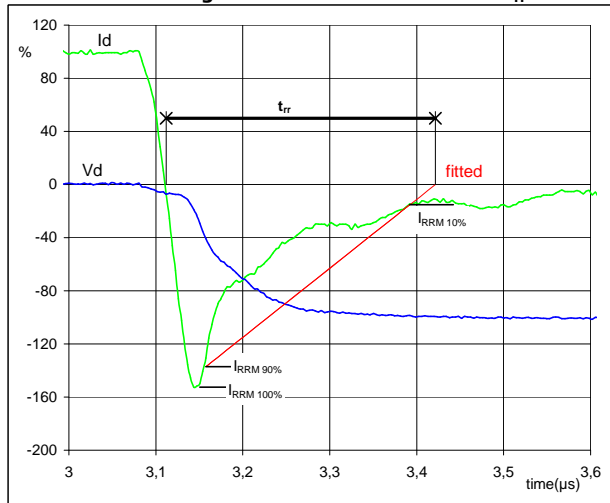
$P_{off} (100\%) = 45,16 \text{ kW}$   
 $E_{off} (100\%) = 6,39 \text{ mJ}$   
 $t_{Eoff} = 0,65 \text{ } \mu\text{s}$

**figure 6. IGBT**  
**Turn-on Switching Waveforms & definition of  $t_{Eon}$**



$P_{on} (100\%) = 45,16 \text{ kW}$   
 $E_{on} (100\%) = 6,39 \text{ mJ}$   
 $t_{Eon} = 0,34 \text{ } \mu\text{s}$

**figure 7. FWD**  
**Turn-off Switching Waveforms & definition of  $t_{rr}$**



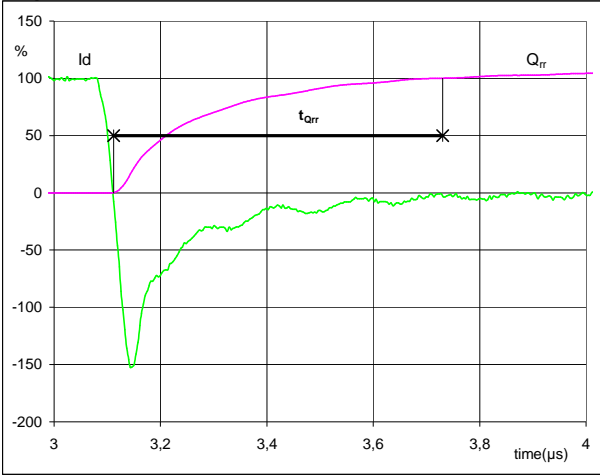
$V_d (100\%) = 600 \text{ V}$   
 $I_d (100\%) = 75 \text{ A}$   
 $I_{RRM} (100\%) = -117 \text{ A}$   
 $t_{rr} = 0,31 \text{ } \mu\text{s}$



# Switching Definitions Output Inverter

**figure 8.** FWD

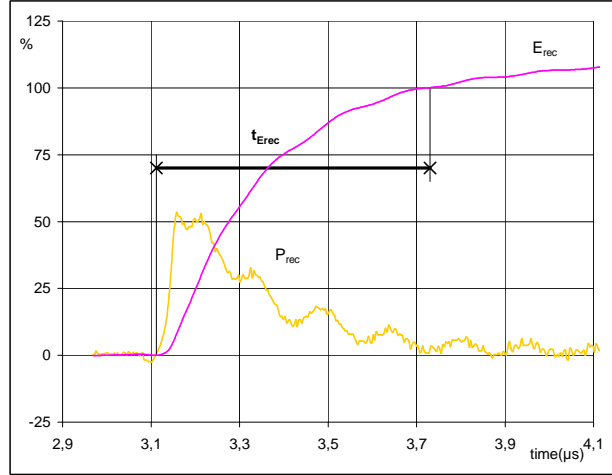
**Turn-on Switching Waveforms & definition of  $t_{Qrr}$**   
( $t_{Qrr}$  = integrating time for  $Q_{rr}$ )



$I_d$ (100%) =	75	A
$Q_{rr}$ (100%) =	14,13	$\mu\text{C}$
$t_{Qint}$ =	0,62	$\mu\text{s}$

**figure 9.** FWD

**Turn-on Switching Waveforms & definition of  $t_{Erec}$**   
( $t_{Erec}$  = integrating time for  $E_{rec}$ )



$P_{rec}$ (100%) =	45,16	kW
$E_{rec}$ (100%) =	5,64	mJ
$t_{Erec}$ =	0,62	$\mu\text{s}$

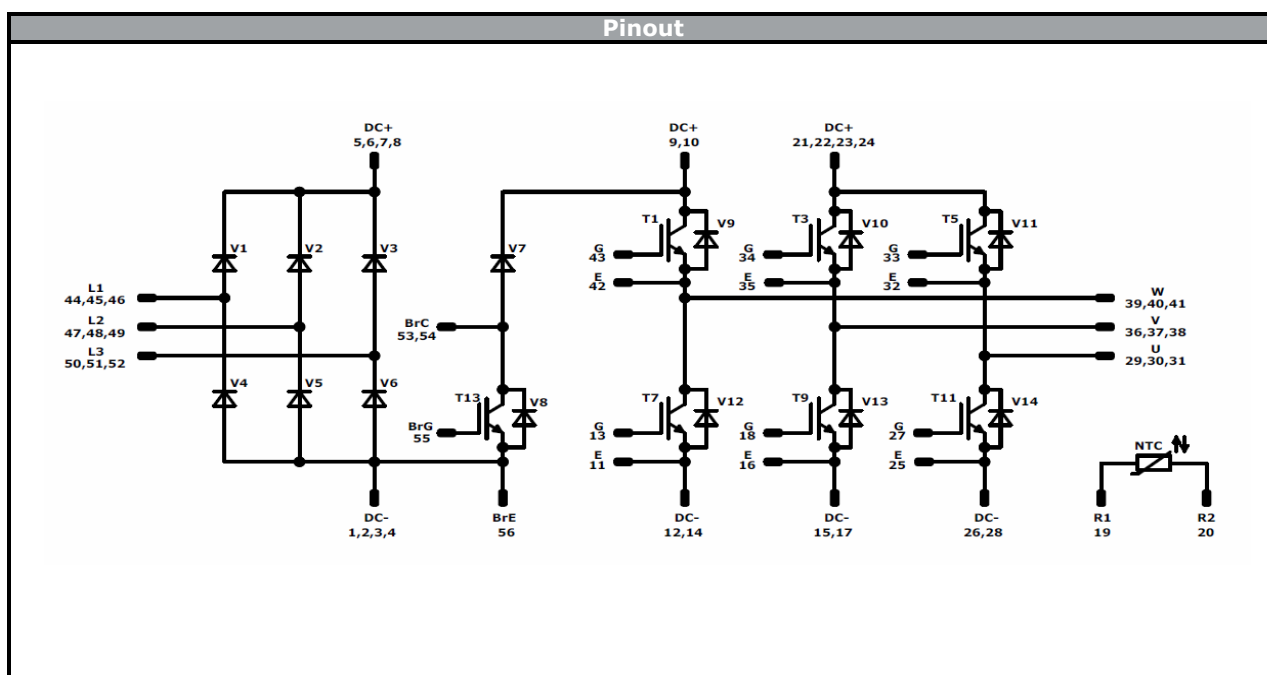


## Ordering Code and Marking - Outline - Pinout

Ordering Code & Marking			
Version	Ordering Code	in DataMatrix as	in packaging barcode as
without thermal paste with Solder pins	V23990-P769-A-PM	P769A	P769A
without thermal paste with Press-fit pins	V23990-P769-AY-PM	P769AY	P769AY
with thermal paste with Solder pins	V23990-P769-A-/3/-PM	P769A	P769A-/3/
with thermal paste with Press-fit pins	V23990-P769-AY-/3/-PM	P769AY	P769AY-/3/

Outline							
Pin table [mm]				Pin table [mm]			
Pin	Func	X	Y	Pin	Func	X	Y
1	DC-	71,2	0	29	U	0	37,2
2	DC-	68,7	0	30	U	2,5	37,2
3	DC-	66,2	0	31	U	5	37,2
4	DC-	63,7	0	32	E	7,8	37,2
5	DC+	55,95	0	33	G	10,6	37,2
6	DC+	53,45	0	34	G	18,45	37,2
7	DC+	55,95	2,8	35	E	21,25	37,2
8	DC+	53,45	2,8	36	V	24,05	37,2
9	DC+	48,4	0	37	V	26,55	37,2
10	DC+	45,9	0	38	V	29,05	37,2
11	E	38,9	0	39	W	36,1	37,2
12	DC-	36,1	0	40	W	38,6	37,2
13	G	38,9	2,8	41	W	41,1	37,2
14	DC-	36,1	2,8	42	E	43,9	37,2
15	DC-	31,3	0	43	G	46,7	37,2
16	E	28,5	0	44	L1	53,7	37,2
17	DC-	31,3	2,8	45	L1	56,2	37,2
18	G	28,5	2,8	46	L1	58,7	37,2
19	R2	19,3	0	47	L2	71,2	37,2
20	R1	19,3	2,8	48	L2	71,2	34,7
21	DC+	12,3	0	49	L2	71,2	32,2
22	DC+	9,8	0	50	L3	71,2	25,2
23	DC+	12,3	2,8	51	L3	71,2	22,7
24	DC+	9,8	2,8	52	L3	71,2	20,2
25	E	2,8	0	53	BrC	71,2	12,8
26	DC-	0	0	54	BrC	68,7	12,8
27	G	2,8	2,8	55	BrG	71,2	5,6
28	DC-	0	2,8	56	BrE	71,2	2,8

Technical drawings of the component showing side views and a top view with dimensions and pin locations. The top view includes a coordinate system with X and Y axes and a tolerance note: "Tolerance of pinposition: ±0.5mm at the end of pins. Dimension of coordinate pins is only offset without tolerance."




Identification					
ID	Component	Voltage	Current	Function	Comment
T1,T3,T5,T7,T9,T11	IGBT	1200V	70A	Inverter Switch	
V9-V14	FWD	1200V	75A	Inverter Diode	
T13	IGBT	1200V	50A	Brake Switch	
V7	FWD	1200V	25A	Brake Diode	
V8	FWD	1200V	10A	Brake Inverse Diode	
V1-V6	Rectifier	1600V	75A	Rectifier Diode	
NTC	NTC			Thermistor	



Packaging instruction			
Standard packaging quantity (SPQ)	36	>SPQ Standard	<SPQ Sample

Handling instruction
Handling instructions for <i>flow 2</i> packages see vincotech.com website.

Package data
Package data for <i>flow 2</i> packages see vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
V23990-P769-Ax-D8-14	05 Jan. 2018	Rth values changed to psx	All

**DISCLAIMER**

The information, specifications, procedures, methods and recommendations herein (together "information") are presented by Vincotech to reader in good faith, are believed to be accurate and reliable, but may well be incomplete and/or not applicable to all conditions or situations that may exist or occur. Vincotech reserves the right to make any changes without further notice to any products to improve reliability, function or design. No representation, guarantee or warranty is made to reader as to the accuracy, reliability or completeness of said information or that the application or use of any of the same will avoid hazards, accidents, losses, damages or injury of any kind to persons or property or that the same will not infringe third parties rights or give desired results. It is reader's sole responsibility to test and determine the suitability of the information and the product for reader's intended use.

**LIFE SUPPORT POLICY**

Vincotech products are not authorised for use as critical components in life support devices or systems without the express written approval of Vincotech.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.